4V drive

TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

# SSM3J112TU

### **High Speed Switching Applications**

• Low on-resistance:  $R_{on} = 790 \text{m}\Omega \text{ (max) } (@V_{GS} = -4 \text{ V})$ 

 $R_{on} = 390 \text{m}\Omega \text{ (max) (@V_{GS} = -10 V)}$ 

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DS}$	-30	V	
Gate-Source voltage		V <sub>GSS</sub>	± 20	V	
Drain current	DC	I <sub>D</sub>	-1.1	Α	
	Pulse	I <sub>DP</sub>	-2.2		
Drain power dissipation		P <sub>D (Note 1)</sub>	800	mW	
		P <sub>D (Note 2)</sub>	500		
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	–55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

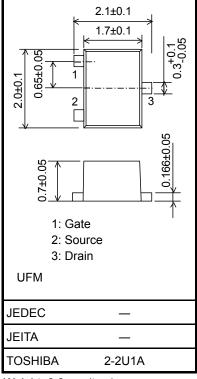
Note 1: Mounted on ceramic board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 0.8 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

Note 2: Mounted on FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

#### Unit: mm



Weight: 6.6 mg (typ.)

# **Electrical Characteristics (Ta = 25°C)**

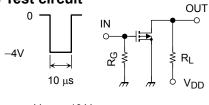
Characte	eristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-30	_	_	٧
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +20 \text{ V}$	-15	_	_	
Drain cut-off curren	t	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	_	_	-1	μА
Gate leakage curre	nt	I <sub>GSS</sub>	$V_{GS} = \pm 16V, V_{DS} = 0$	_	_	±1	μА
Gate threshold volta	age	V <sub>th</sub>	$V_{DS} = -5 \text{ V}, I_D = -0.1 \text{ mA}$	-0.8	_	-1.8	V
Forward transfer ad	mittance	Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_D = -0.5 \text{ A}$ (Note3)	0.5	1.0	_	S
Drain-Source on-resistance		R <sub>DS</sub> (ON)	$I_D = -0.5 \text{ A}, V_{GS} = -10 \text{ V}$ (Note3)	_	310	390	- mΩ
			$I_D = -0.5 \text{ A}, V_{GS} = -4 \text{ V}$ (Note3)	_	610	790	
Input capacitance		C <sub>iss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	86	_	pF
Output capacitance		$C_{OSS}$ $V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	25	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	14	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -15 \text{ V}, I_D = -0.5 \text{ A},$	_	14	_	ns
	Turn-off time	t <sub>off</sub>	$V_{GS} = 0$ to $-4$ V, $R_G = 10 \Omega$	_	8.5	_	
Drain-Source forward voltage		V <sub>DSF</sub>	$I_D = 1.1A, V_{GS} = 0 V$ (Note3)	_	0.85	1.2	V

Note3: Pulse test

Start of commercial production 2005-02

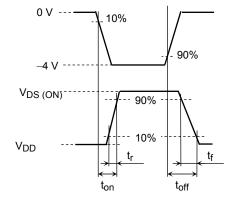
# **Switching Time Test Circuit**





(b) V<sub>IN</sub>

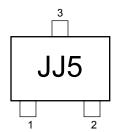
(c) Vout

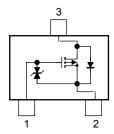


- $V_{DD} = -10 \text{ V}$
- $R_G = 4.7 \Omega$
- Duty ≤ 1%
- $V_{IN}\text{: }t_{f},\,t_{f}<5\text{ ns}$  Common Source
- Ta = 25°C

## Marking

# **Equivalent Circuit (top view)**





#### **Precaution**

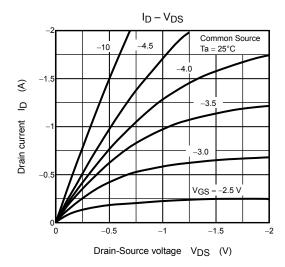
 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D$ =-0.1mA for this product. For normal switching operation,  $V_{GS\ (on)}$  requires a higher voltage than  $V_{th}$ , and  $V_{GS\ (off)}$  requires a lower voltage than  $V_{th}$ .

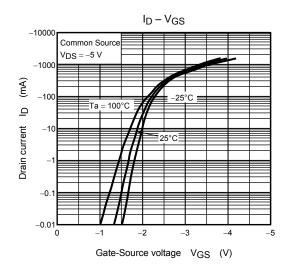
(The relationship can be established as follows: V<sub>GS</sub> (off) < V<sub>th</sub> < V<sub>GS</sub> (on))

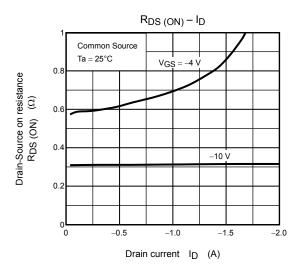
Take this into consideration when using the device.

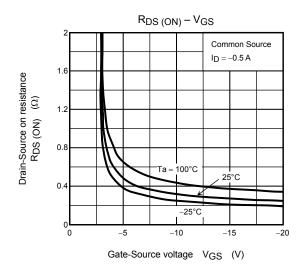
### **Handling Precaution**

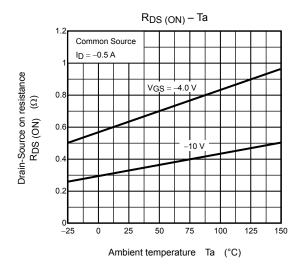
When handling individual devices which are not yet mounted on a circuit board, be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

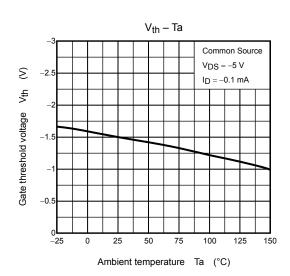


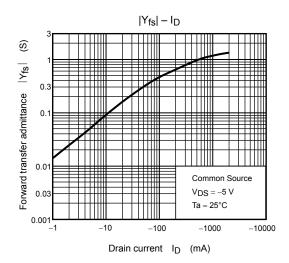


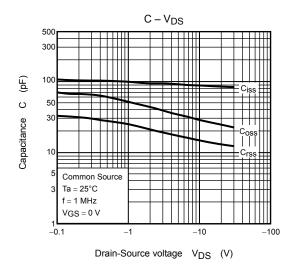


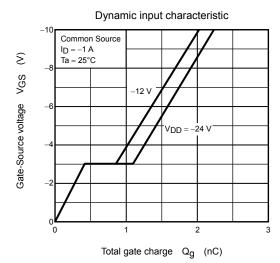


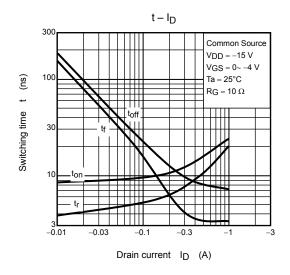


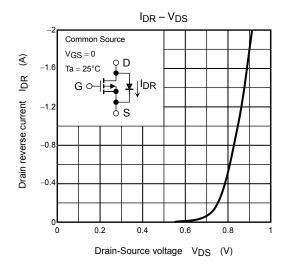


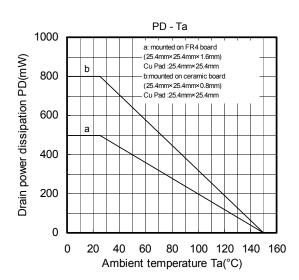




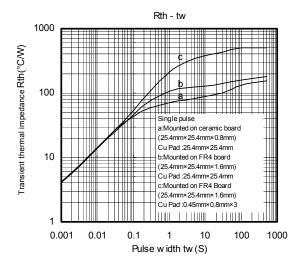








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